# Product End-of-Life Disassembly Instructions

**Product Category:** Personal Computers  

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**Marketing Name / Model**  
[List multiple models if applicable.]

HP EliteOne 800 G5 23.8-in Healthcare Edition All-in-One

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**Purpose:** The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

## 1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

<table>
<thead>
<tr>
<th>Item Description</th>
<th>Notes</th>
<th>Quantity of items included in product</th>
</tr>
</thead>
<tbody>
<tr>
<td>Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)</td>
<td>With a surface greater than 10 sq cm MotherBoard, RAM, SSD,</td>
<td>4</td>
</tr>
<tr>
<td>Batteries</td>
<td>All types including standard alkaline and lithium coin or button style batteries RTC battery</td>
<td>1</td>
</tr>
<tr>
<td>Mercury-containing components</td>
<td>For example, mercury in lamps, display backlights, scanner lamps, switches, batteries</td>
<td></td>
</tr>
<tr>
<td>Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm</td>
<td>Includes background illuminated displays with gas discharge lamps LED LCD</td>
<td>1</td>
</tr>
<tr>
<td>Cathode Ray Tubes (CRT)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Capacitors / condensers (Containing PCB/PCT)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height</td>
<td></td>
<td></td>
</tr>
<tr>
<td>External electrical cables and cords</td>
<td>Power cord</td>
<td>1</td>
</tr>
<tr>
<td>Gas Discharge Lamps</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Plastics containing Brominated Flame Retardants weighing &gt; 25 grams (not including PCBs or PCAs already listed as a separate item above)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner</td>
<td>Include the cartridges, print heads, tubes, vent chambers, and service stations.</td>
<td></td>
</tr>
<tr>
<td>Components and waste containing asbestos</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Components, parts and materials containing refractory ceramic fibers</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
Components, parts and materials containing radioactive substances

### 2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

<table>
<thead>
<tr>
<th>Tool Description</th>
<th>Tool Size (if applicable)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Screwdriver</td>
<td>TORX T8</td>
</tr>
</tbody>
</table>

### 3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Removed Stand Base
2. Removed Rear Cover
3. Removed Fan Brket
4. Removed IO Door
5. Removed IO Holder
6. Removed Fan Cover and Fan
7. Removed Thermal Module
8. Removed Camera Module
9. Removed Speaker
10. Removed Power Supplier
11. Removed ODD and ODD latch
12. Removed HDD Brket and HDD
13. Removed Audio PCA
14. Removed Finger print PCA and Power Board
15. Removed RAM
16. Removed MotherBoard
17. Removed Base Pan
18. Removed Front Bezel
19. Removed LCD Panel
20. Removed Wire Lan card and SSD

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

1. Removed Stand Base

PSG instructions for this template are available at [EL-MF877-01](EL-MF877-01)
2. Removed Rear Cover

3. Removed Fan Bracket

4. Remove IO Door

5. Removed IO Holder

6. Removed Fan Cover and Fan

PSG instructions for this template are available at EL-MF877-01
7. Removed Thermal Module

8. Removed Camera Module

9. Removed Speaker
10. Removed Power Supplier

11. Removed ODD and ODD latch

12. Removed HDD Bracket and HDD

13. Removed Audio PCA

14. Removed RAM
15. Removed MotherBoard

16. Removed Base Pan

17. Removed Front Bezel
18. Removed LCD Panel

19. Removed Wire Lan card and SSD